

P-Channel 1.8-V (G-S) MOSFET

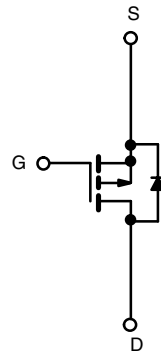
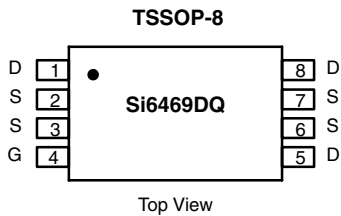
PRODUCT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
- 8	0.028 at V _{GS} = - 4.5 V	± 6.0
	0.031 at V _{GS} = - 3.3 V	± 5.8
	0.040 at V _{GS} = - 2.5 V	± 5.0
	0.065 at V _{GS} = - 1.8 V	± 3.6

FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFETs: 1.8 V Rated



RoHS
COMPLIANT



Ordering Information: Si6469DQ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 8	V		
Gate-Source Voltage	V _{GS}	± 8			
Continuous Drain Current (T _J = 150 °C) ^{a, b}	I _D	T _A = 25 °C	± 6.0	A	
		T _A = 70 °C	± 5.0		
Pulsed Drain Current	I _{DM}	± 30			
Continuous Source Current (Diode Conduction) ^{a, b}	I _S	- 1.25			
Maximum Power Dissipation ^{a, b}	P _D	T _A = 25 °C	1.5	W	
		T _A = 70 °C	1.0		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R _{thJA}	t ≤ 10 s	83	°C/W	
		Steady State	95		

Notes:

a. Surface Mounted on FR4 board.

b. t ≤ 10 s.

For SPICE model information via the Worldwide Web: <http://www.vishay.com/www/product/spice.htm>.

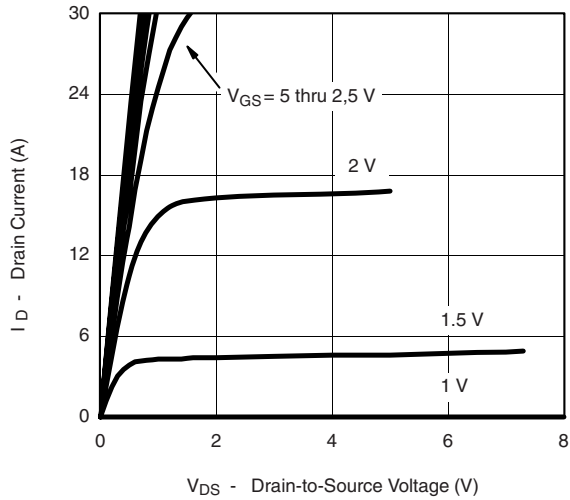
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ. ^b	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$	-0.45			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 8\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -6.4\text{ V}, V_{GS} = 0\text{ V}$			-1	μA
		$V_{DS} = -6.4\text{ V}, V_{GS} = 0\text{ V}, T_J = 70\text{ }^\circ\text{C}$			-25	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq -8\text{ V}, V_{GS} = -4.5\text{ V}$	-30			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -6.0\text{ A}$		0.021	0.028	Ω
		$V_{GS} = -3.3\text{ V}, I_D = -5.8\text{ A}$		0.024	0.031	
		$V_{GS} = -2.5\text{ V}, I_D = -5.0\text{ A}$		0.030	0.040	
		$V_{GS} = -1.8\text{ V}, I_D = -3.6\text{ A}$		0.048	0.065	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -8\text{ V}, I_D = -6.0\text{ A}$		18		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -1.25\text{ A}, V_{GS} = 0\text{ V}$		-0.68	-1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -6\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -6.0\text{ A}$		20	40	nC
Gate-Source Charge	Q_{gs}		4.5			
Gate-Drain Charge	Q_{gd}		3.6			
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6\text{ V}, R_L = 6\text{ }\Omega$ $I_D \cong -1\text{ A}, V_{GEN} = -4.5\text{ V}, R_G = 6\text{ }\Omega$		20	50	ns
Rise Time	t_r			30	60	
Turn-Off Delay Time	$t_{d(off)}$			85	150	
Fall Time	t_f			50	90	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = -1.25\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$		50	100	

Notes:

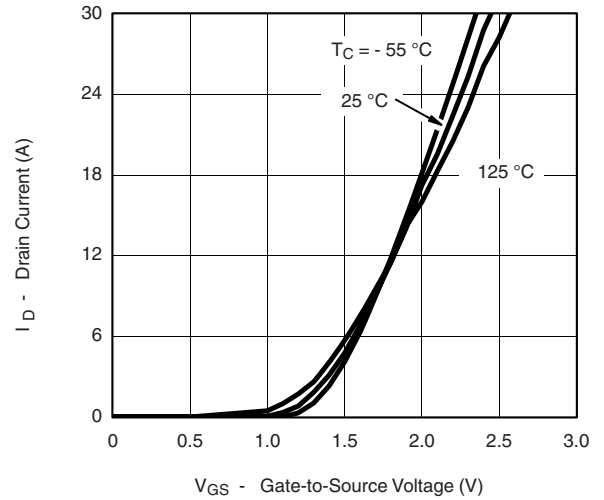
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

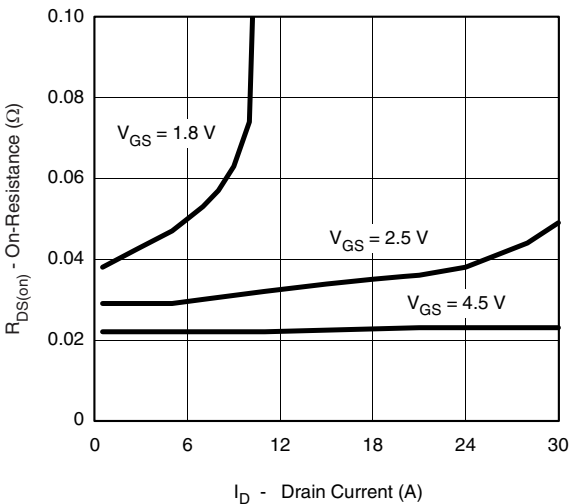
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



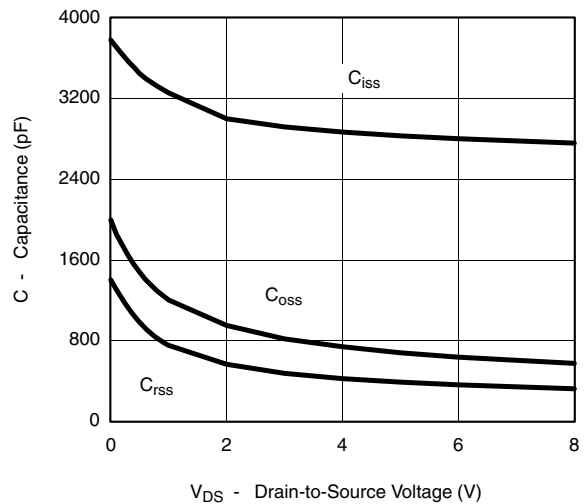
Output Characteristics



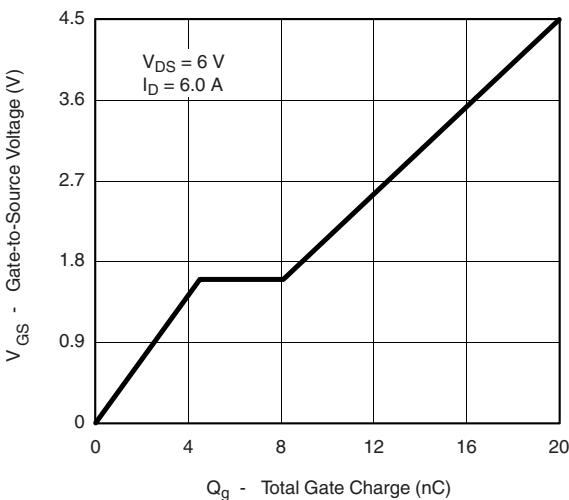
Transfer Characteristics



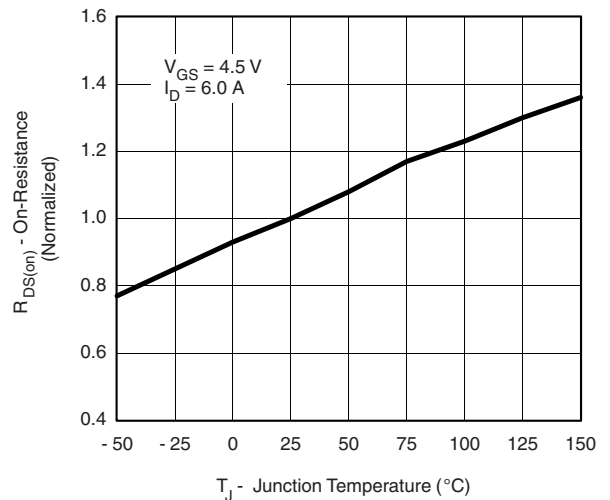
On-Resistance vs. Drain Current



Capacitance

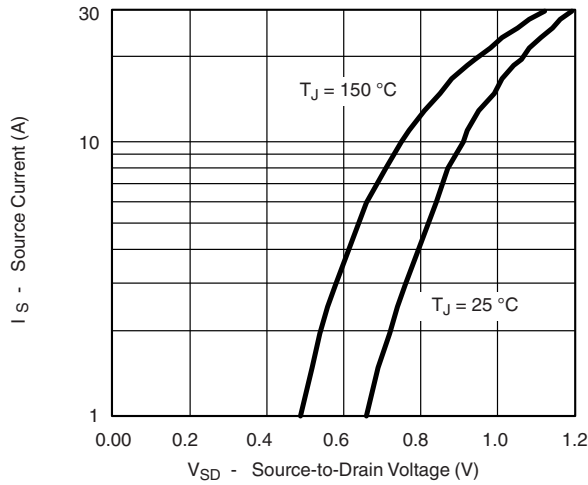


Gate Charge

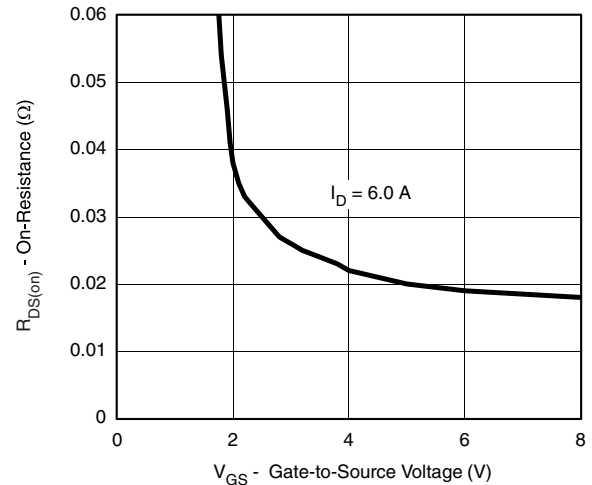


On-Resistance vs. Junction Temperature

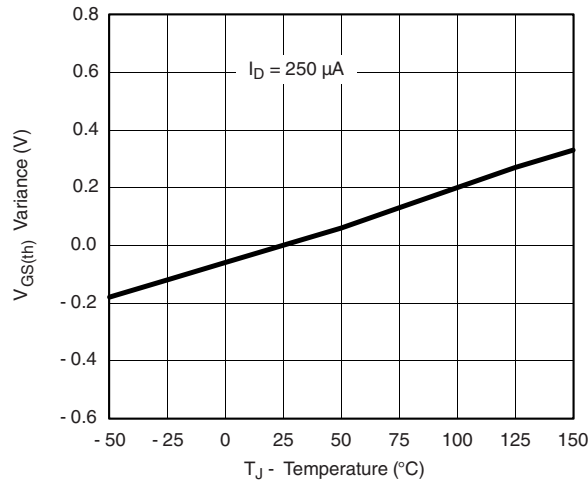
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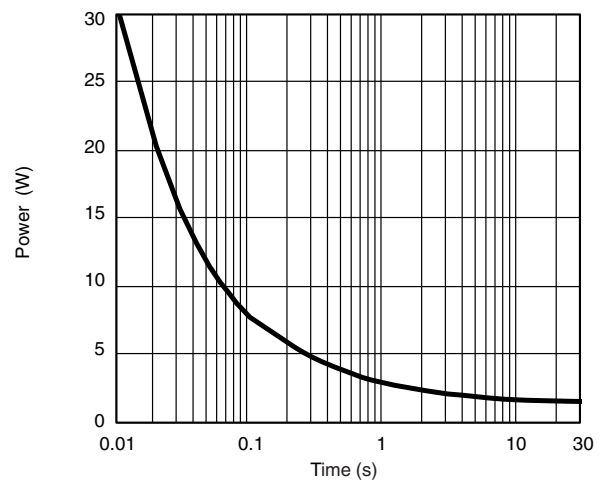
Source-Drain Diode Forward Voltage



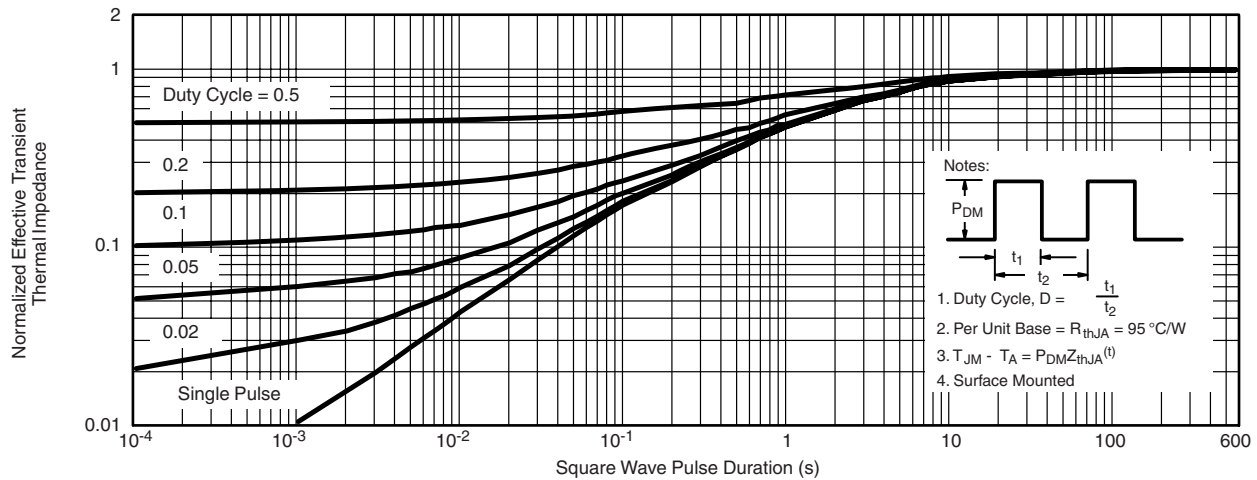
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient

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